



March 6,2006

The purpose of this letter is to outline the different versions of the WER-1 module. The WER-1 module exists in four different versions. Internally, they are named HIP, HUB, MCU, and COLUMN. All four versions use the same circuit board.

The difference between modules is the population of components on the board. All versions include the RF transceiver and microcontroller. The various versions have differences in installed connectors and analog circuitry.

For testing purposes, a super-populated sample was used. This sample included all components from all versions. This is not a production configuration, but it means that all production versions are de-populated versions of the test sample.

A handwritten signature in black ink on a light-colored background. The signature reads "Joseph Perret" in a cursive script.